

»Features

- 90Watts peak pulse power ($t_p = 8/20\mu s$)
- Tiny SOT563 package
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- Protection five data/power line
- IEC 61000-4-2 $\pm 8kV$ contact $\pm 15kV$ air
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 7.5A (8/20 μs)

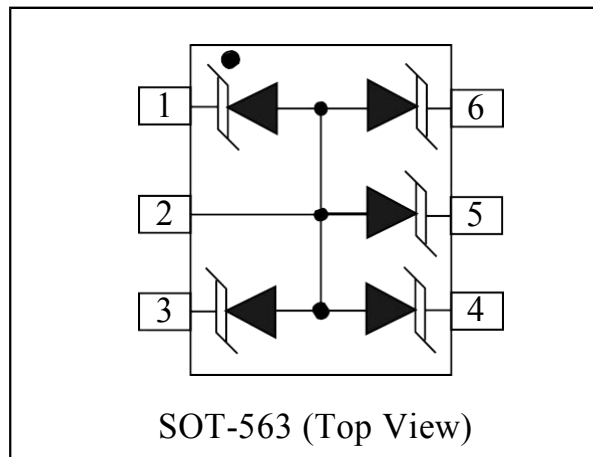
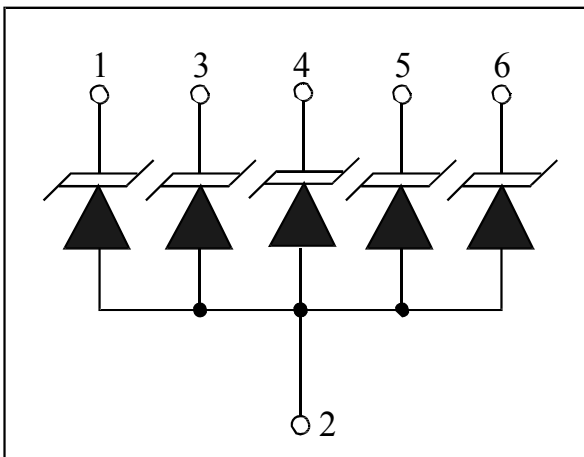
»Applications

- Cellular Handsets & Accessories
- Personal Digital Assistants (PDAs)
- Notebooks & Handhelds
- Portable Instrumentation
- Digital Cameras

»Mechanical Data

- SOT563 package
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

»Schematic & PIN Configuration



»Absolute Maximum Rating

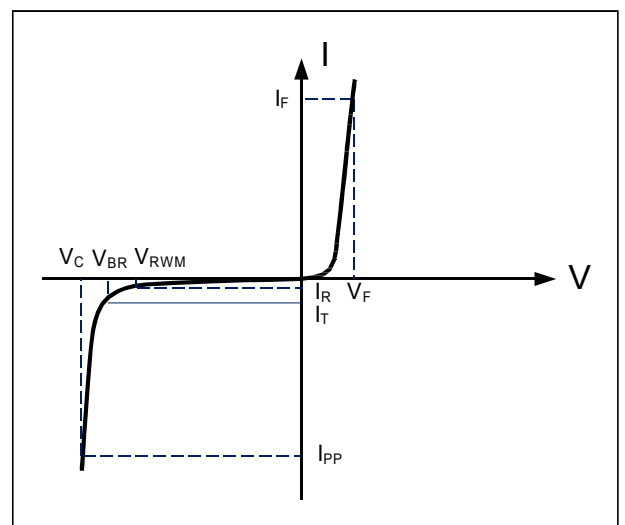
Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{PP}	90	Watts
Peak Pulse Current ($t_p = 8/20\mu s$) (note1)	I_{pp}	7.5	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	15 8	kV
Lead Soldering Temperature	T_L	260(10seconds)	°C
Junction Temperature	T_J	-55 to + 125	°C
Storage Temperature	T_{stg}	-55 to + 125	°C

»Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V_{RWM}				5.0	V
Reverse Breakdown Voltage	V_{BR}	$I_T = 1mA$	6.0			V
Reverse Leakage Current	I_R	$V_{RWM} = 5V, T = 25^\circ C$		50	500	nA
Clamping Voltage	V_C	$I_{PP} = 7.5A, t_p = 8/20\mu s$			12	V
Junction Capacitance	C_j	$V_R = 0V, f = 1MHz$ IO to IO		20		pF
		$V_R = 0V, f = 1MHz$ IO to GND		40		

»Electrical Parameters (TA = 25°C unless otherwise noted)

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current



Note: 8/20µs pulse waveform.

»Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

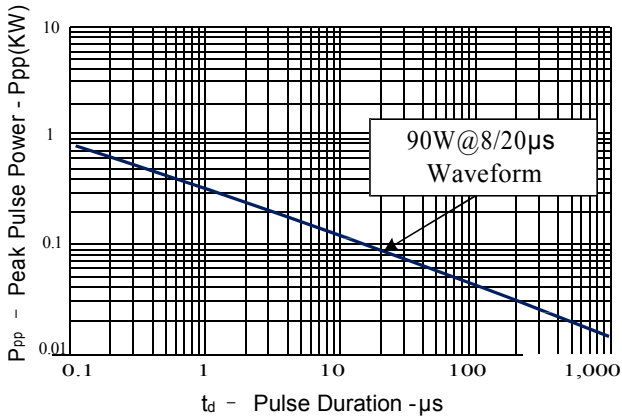


Figure 2: Power Derating Curve

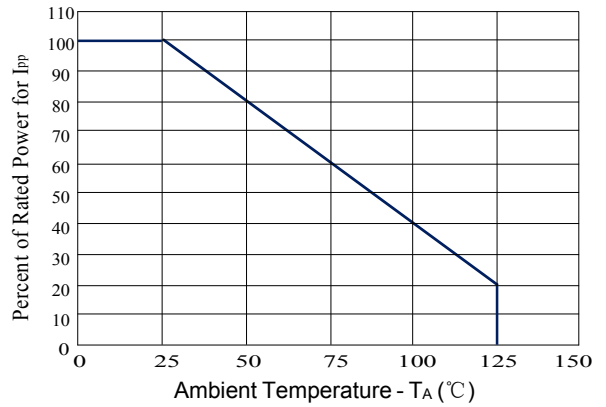


Figure3: Pulse Waveform

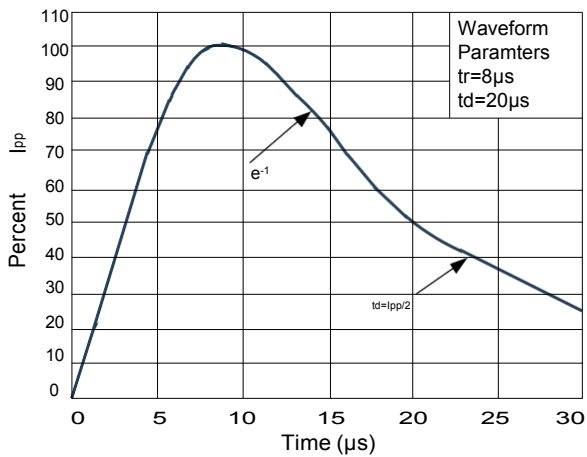


Figure 4: Clamping Voltage vs. Ipp

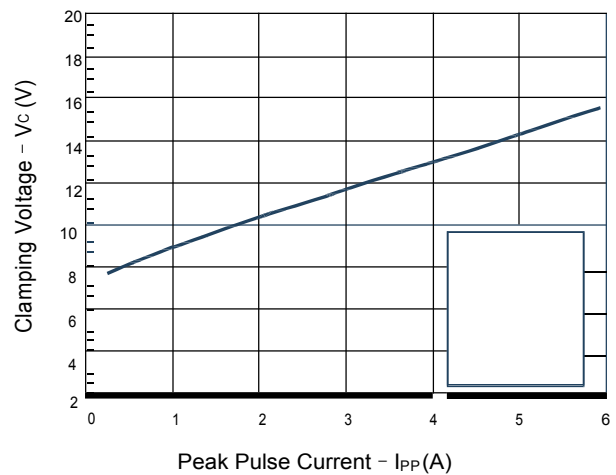


Figure 5: Insertion Loss

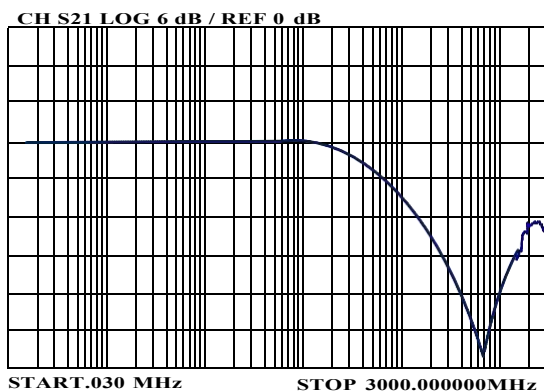
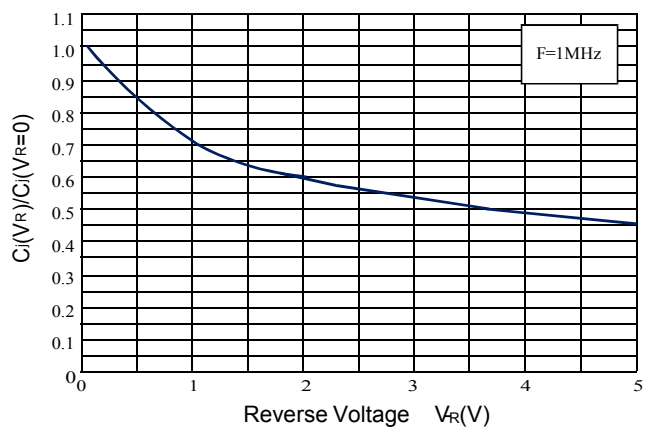
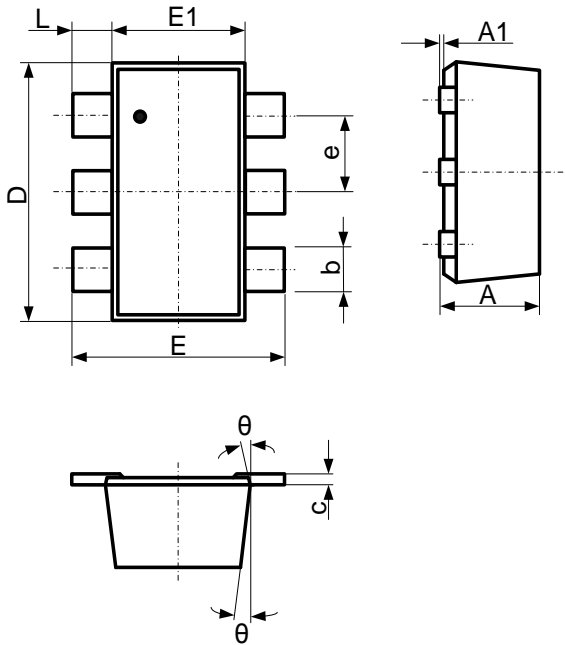


Figure 6: Normalized Junction Capacitance vs. Reverse Voltage

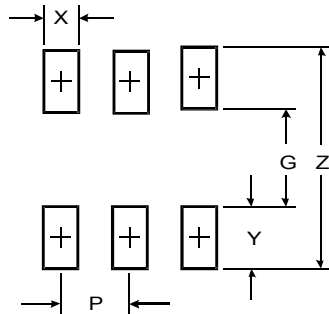


»Outline Drawing – SOT563

PACKAGE OUTLINE



DIMENSIONS				
SYMBOL	INCHES		MILLIMETER	
	MIN	MAX	MIN	MAX
A	0.021	0.024	0.525	0.600
A1	0.000	0.002	0.000	0.050
e	0.018	0.022	0.450	0.550
c	0.004	0.006	0.090	0.160
D	0.059	0.067	1.500	1.700
b	0.007	0.011	0.170	0.270
E1	0.043	0.051	1.100	1.300
E	0.059	0.067	1.500	1.700
L	0.004	0.012	0.100	0.300
θ	7°REF		7°REF	



DIMENSIONS		
DIM	INCHES	MILLIMETERS
Z	0.0752	1.91
G	0.0350	0.89
P	0.020TYP	0.51 TYP
X	0.0118	0.3
Y	0.0201	0.51

»Marking



»Ordering information

Order code	Package	Base qty	Delivery mode
BST563A055V	SOT563	3k	Tape and reel